

100kHz, 670nA, Non-Unity Gain, Rail-to-Rail I/O CMOS Operational Amplifier

FEATURES

- **GAIN BANDWIDTH:**100kHz
- **RAIL-TO-RAIL INPUT AND OUTPUT**
1mV Typical Vos
- **INPUT VOLTAGE RANGE:** -0.1V to +5.6V
with Vs = 5.5V
- **SUPPLY RANGE:** +1.4V to +5.5V
- **STABLE FOR GAINS ≥ 10**
- **SPECIFIED UP TO +125°C**
- **Micro SIZE PACKAGES:** SOT23-5

APPLICATIONS

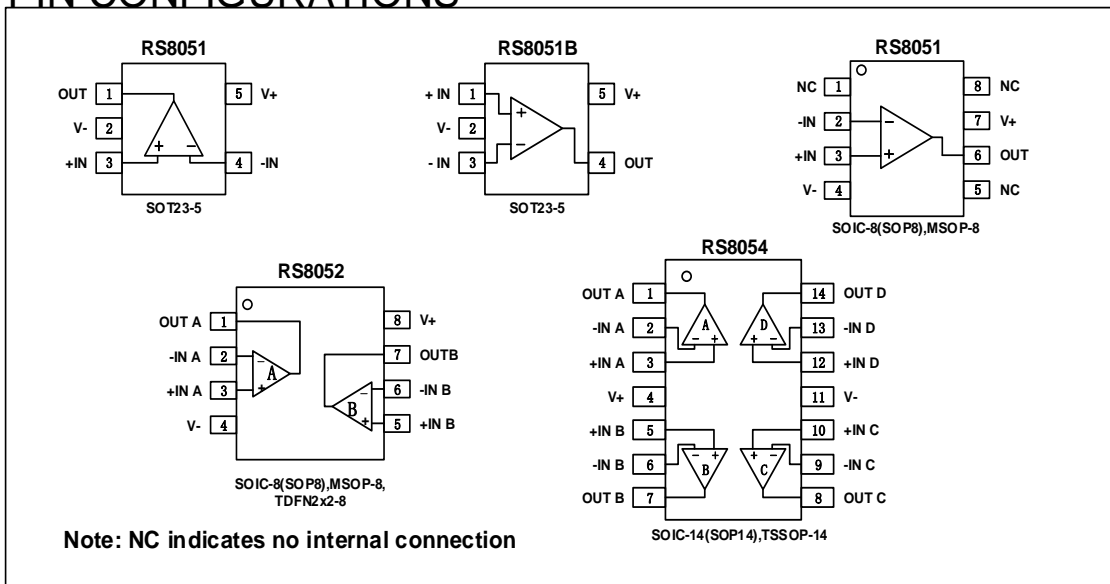
- **SENSORS**
- **PHOTODIODE AMPLIFICATION**
- **WEARABLE PRODUCTS**
- **TEMPERATURE MEASUREMENT**
- **BATTERY POWERED SYSTEM**

DESCRIPTION

The RS8051, RS8052, RS8054, families of products offer low voltage operation and rail-to-rail input and output, as well as excellent speed/power consumption ratio, providing an excellent bandwidth (100kHz) and slew rate of 30V/ms. The op-amps are stable for gains ≥ 10 and feature an ultra-low input bias current.

The devices are ideal for sensor interfaces, active filters and portable applications. The RS8051, RS8052, RS8054 families of operational amplifiers are specified at the full temperature range of -40°C to $+125^{\circ}\text{C}$ under single or dual power supplies of 1.4V to 5.5V.

PIN CONFIGURATIONS



ABSOLUTE MAXIMUM RATINGS ⁽¹⁾

Supply Voltage, V+ to V-	7.0V
Input Terminals, Voltage ⁽²⁾	- 0.5 to (V+) + 0.5V
Current ⁽²⁾	±10mA
Storage Temperature	-65°C to +150°C
Operating Temperature	-40°C to +125°C
Junction Temperature	150°C
Package Thermal Resistance @ T _A = +25°C	
SOT23-5, SOT23-6	200°C/W
MSOP-10, SOIC-8	150°C/W
SOIC-14, TSSOP-14	100°C/W
Lead Temperature (Soldering, 10s)	260°C
ESD Susceptibility	
HBM	5000V
MM	400V


ESD SENSITIVITY CAUTION

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

- (1) Stresses above these ratings may cause permanent damage. Exposure to absolute maximum conditions for extended periods may degrade device reliability. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those specified is not implied.
- (2) Input terminals are diode-clamped to the power-supply rails. Input signals that can swing more than 0.5V beyond the supply rails should be current-limited to 10mA or less.

PACKAGE/ORDERING INFORMATION

PRODUCT	ORDERING NUMBER	TEMPERATURE RANGE	PACKAGE LEAD	PACKAGE MARKING	PACKAGE OPTION
RS8051	RS8051XK	-40°C~125°C	SOIC-8(SOP8)	RS8051	Tape and Reel,2500
	RS8051XF	-40°C~125°C	SOT23-5	8051	Tape and Reel,3000
	RS8051BXF	-40°C~125°C	SOT23-5	8051B	Tape and Reel,3000
	RS8051XM	-40°C~125°C	MSOP-8	RS8051	Tape and Reel,3000
RS8052	RS8052XK	-40°C~125°C	SOIC-8(SOP8)	RS8052	Tape and Reel,2500
	RS8052XM	-40°C~125°C	MSOP-8	RS8052	Tape and Reel,3000
	RS8052XTDE8	-40°C~125°C	TDFN2x2-8	RS8052	Tape and Reel,3000
RS8054	RS8054XP	-40°C~125°C	SOIC-14(SOP14)	RS8054	Tape and Reel,2500
	RS8054XQ	-40°C~125°C	TSSOP-14	RS8054	Tape and Reel,3000

ELECTRICAL CHARACTERISTICS

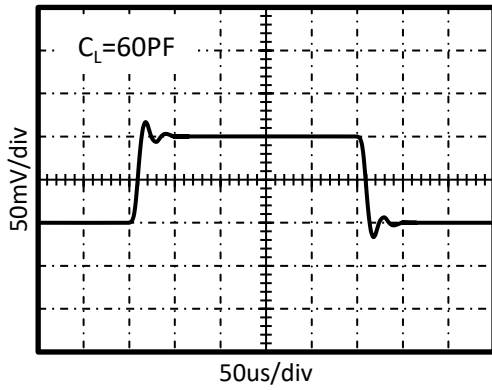
 (At $T_A = +25^\circ\text{C}$, $V_S = 5.0\text{V}$, $R_L = 1\text{M}\Omega$ connected to $V_S/2$, and $V_{OUT} = V_S/2$, unless otherwise noted.)

PARAMETER		CONDITIONS	RS8051,RS8052,RS8054			UNITS
			MIN	TYP	MAX	
POWER SUPPLY						
V_S	Operating Voltage Range		1.4		5.5	V
I_Q	Quiescent Current/Amplifier			670	1500	nA
PSRR	Power-Supply Rejection Ratio	$V_S = 1.4\text{V to } 5.5\text{V}$, $V_{cm} = (V_-) + 0.5\text{V}$	60	70		dB
INPUT						
V_{os}	Input Offset Voltage	$V_{cm} = V_S/2$		1	5	mV
$\Delta V_{os}/\Delta T$	Input Offset Voltage Drift	$V_{cm} = V_S/2$, $-40^\circ\text{C} \leq T_A \leq 125^\circ\text{C}$		2.3		$\mu\text{V}/^\circ\text{C}$
I_B	Input Bias Current			1	10	pA
I_{os}	Input Offset Current			1	10	pA
V_{cm}	Common-Mode Voltage Range	$V_S = 5.5\text{V}$	-0.1		5.6	V
CMRR	Common-Mode Rejection Ratio	$V_S = 5.5\text{V}$, $V_{cm} = -0.1\text{V to } 4\text{V}$	63	75		dB
		$V_S = 5.5\text{V}$, $V_{cm} = -0.1\text{V to } 5.6\text{V}$	58	70		dB
OUTPUT						
AOL	Open-Loop Voltage Gain	$V_S = 1.4\text{V}$, $R_L = 50\text{k}\Omega$, $V_o = V_S - 0.1\text{V}$	62	80		dB
		$V_S = 5.0\text{V}$, $R_L = 50\text{k}\Omega$, $V_o = V_S - 0.1\text{V}$	65	85		dB
	Output Swing From Rail	$R_L = 50\text{k}\Omega$		5		mV
I_{out}	Output Short-Circuit Current			30		mA
FREQUENCY RESPONSE						
SR	Slew Rate			30		V/ms
GBP	Gain-Bandwidth Product			100		kHz
PM	Phase Margin			60		°
NOISE						
e_{n-p-p}	Input Voltage Noise	$f = 0.1\text{ Hz to } 10\text{ Hz}$		2.4		μV_{pp}
e_n	Input Voltage Noise Density	$f = 1\text{ kHz}$		160		$\text{nV}/\sqrt{\text{Hz}}$

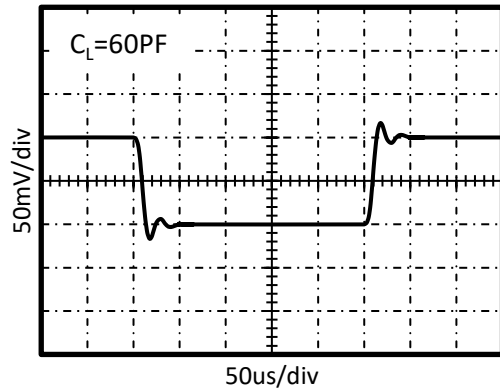
TYPICAL CHARACTERISTICS

At $T_A = +25^\circ\text{C}$, $V_S = 5\text{V}$, $R_L = 1\text{M}\Omega$ connected to $V_S/2$, $C_L = 60\text{pF}$ $V_{CM} = V_S/2$, unless otherwise noted.

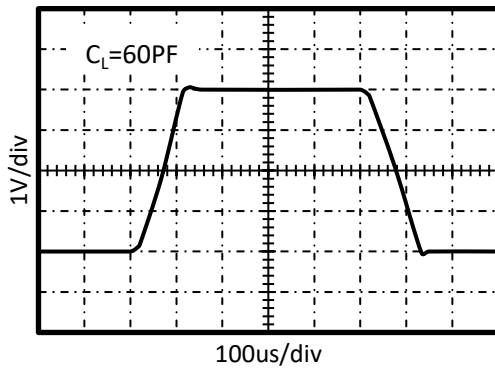
SMALL-SIGNAL STEP RESPONSE



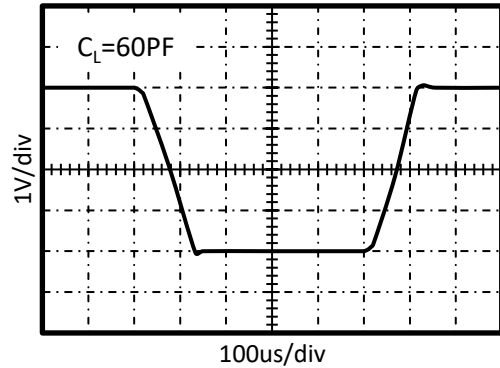
SMALL-SIGNAL STEP RESPONSE



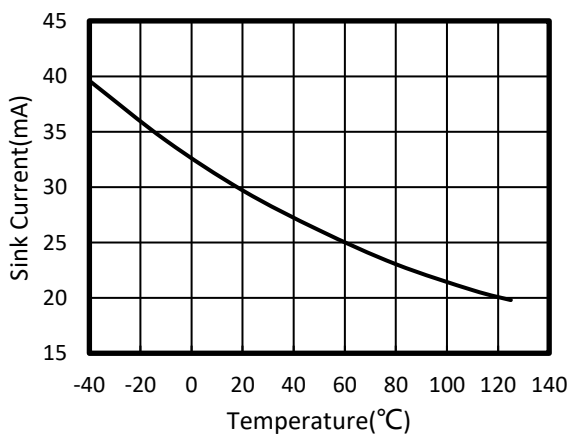
LARGE-SIGNAL STEP RESPONSE



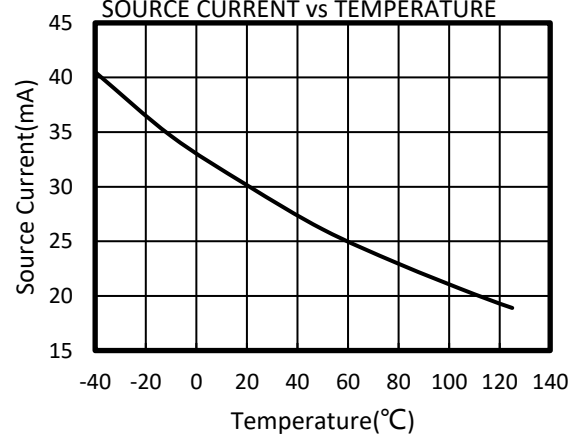
LARGE-SIGNAL STEP RESPONSE



SINK CURRENT vs TEMPERATURE

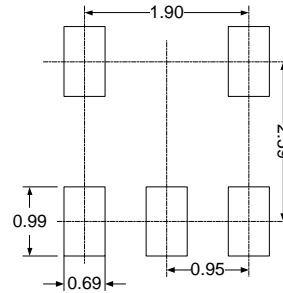
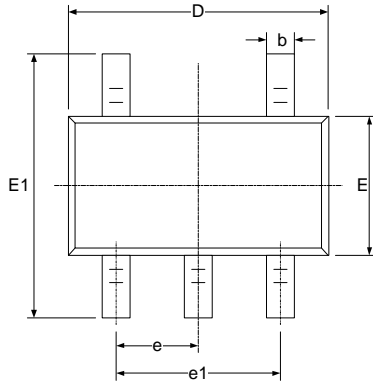


SOURCE CURRENT vs TEMPERATURE

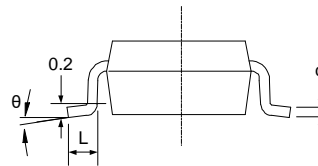
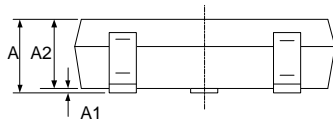


PACKAGE OUTLINE DIMENSIONS

SOT23-5

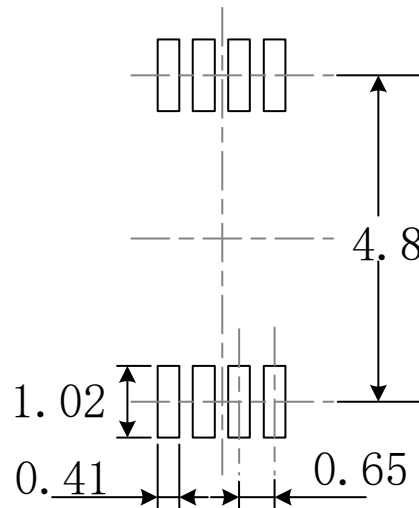
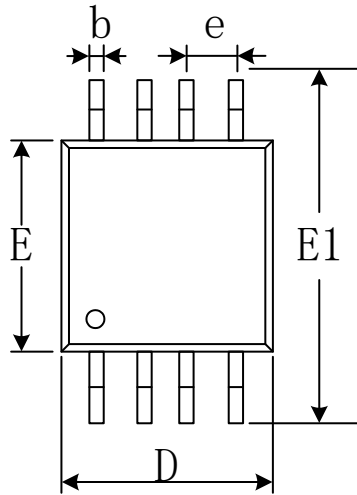


RECOMMENDED LAND PATTERN (Unit: mm)

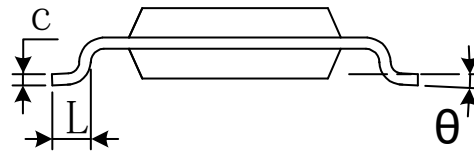
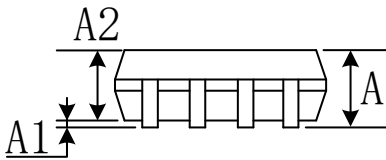


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.500	0.012	0.020
c	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E	1.500	1.700	0.059	0.067
E1	2.650	2.950	0.104	0.116
e	0.950(BSC)		0.037(BSC)	
e1	1.800	2.000	0.071	0.079
L	0.300	0.600	0.012	0.024
θ	0°	8°	0°	8°

MSOP-8

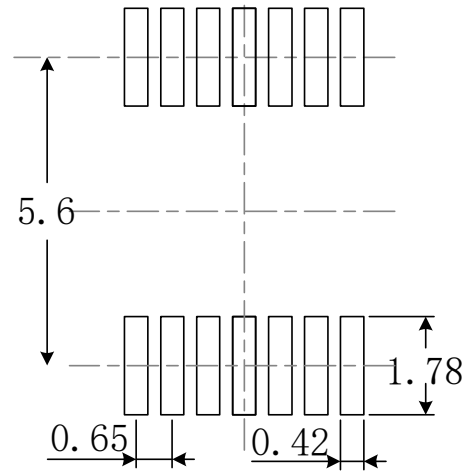
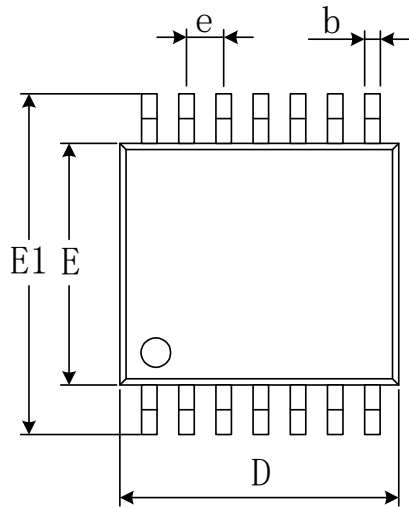
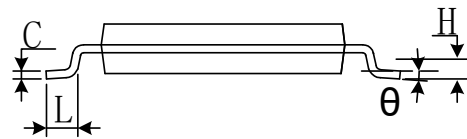
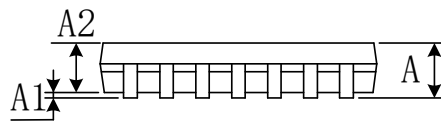


RECOMMENDED LAND PATTERN (Unit: mm)



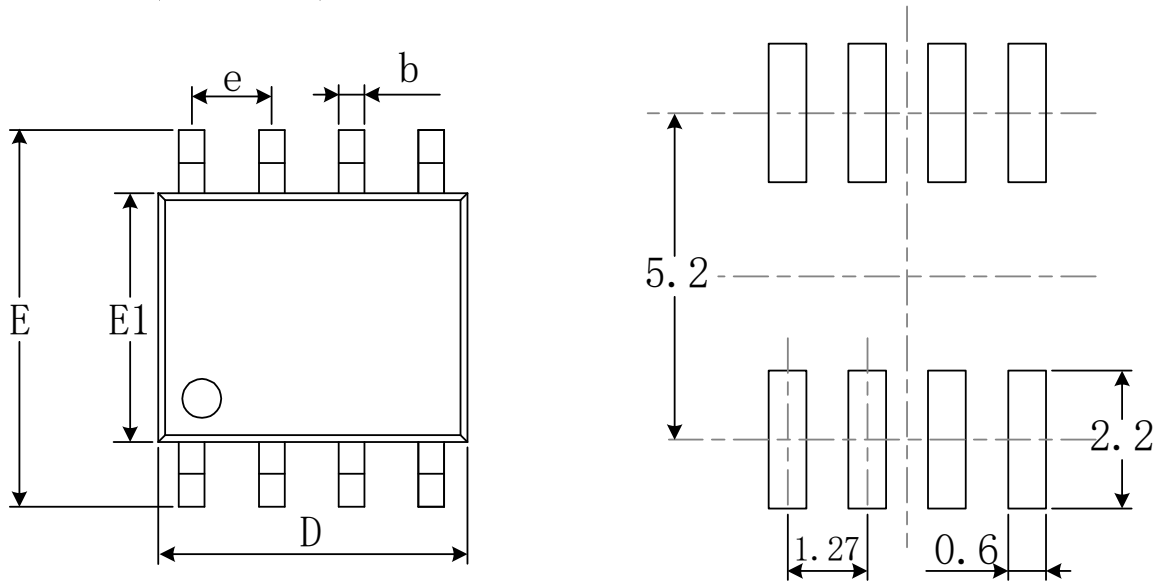
Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.820	1.100	0.032	0.043
A1	0.020	0.150	0.001	0.006
A2	0.750	0.950	0.030	0.037
b	0.250	0.380	0.010	0.015
c	0.090	0.230	0.004	0.009
D	2.900	3.100	0.114	0.122
e	0.650(BSC)		0.026(BSC)	
E	2.900	3.100	0.114	0.122
E1	4.750	5.050	0.187	0.199
L	0.400	0.800	0.016	0.031
θ	0°	6°	0°	6°

TSSOP-14

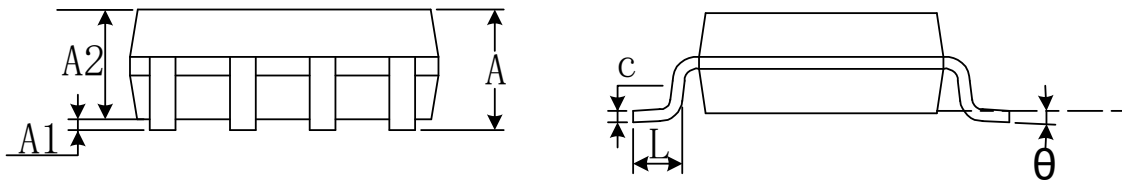

RECOMMENDED LAND PATTERN (Unit: mm)


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A		1.200		0.047
A1	0.050	0.150	0.002	0.006
A2	0.800	1.050	0.031	0.041
b	0.190	0.300	0.007	0.012
c	0.090	0.200	0.004	0.008
D	4.860	5.100	0.191	0.201
E	4.300	4.500	0.169	0.177
E1	6.250	6.550	0.246	0.258
e	0.650(BSC)		0.026(BSC)	
L	0.500	0.700	0.020	0.028
H	0.25(TYP)		0.01(TYP)	
θ	1°	7°	1°	7°

SOIC-8(SOP8)

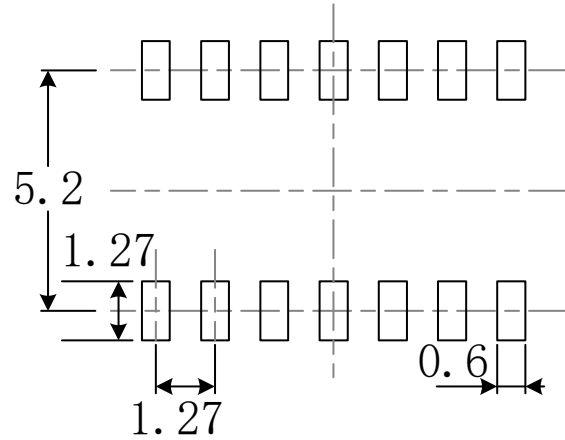
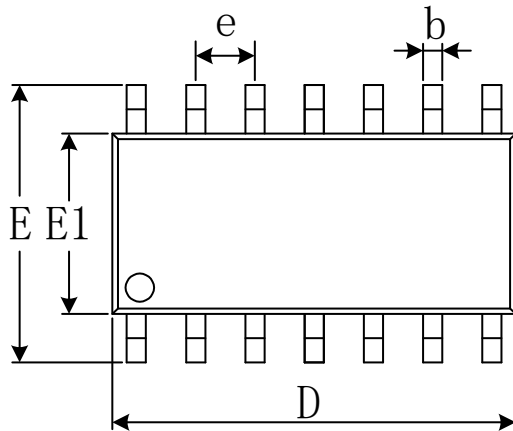


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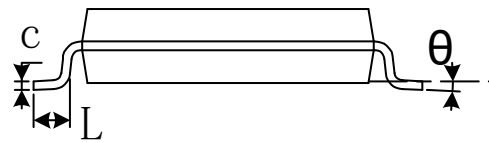
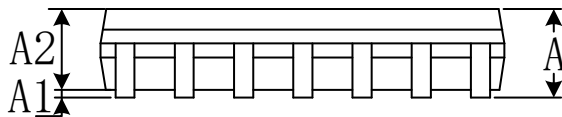


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.013	0.020
c	0.170	0.250	0.007	0.010
D	4.800	5.000	0.189	0.197
e	1.270(BSC)		0.050(BSC)	
E	5.800	6.200	0.228	0.244
E1	3.800	4.000	0.150	0.157
L	0.400	1.270	0.016	0.050
θ	0°	8°	0°	8°

SOIC-14(SOP14)

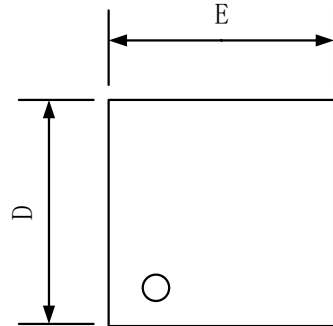


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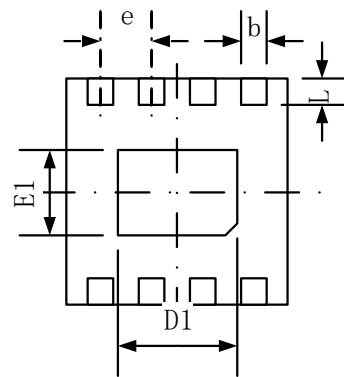


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.310	0.510	0.012	0.020
c	0.100	0.250	0.004	0.010
D	8.450	8.850	0.333	0.348
e	1.270(BSC)		0.050(BSC)	
E	5.800	6.200	0.228	0.244
E1	3.800	4.000	0.150	0.157
L	0.400	1.270	0.016	0.050
θ	0°	8°	0°	8°

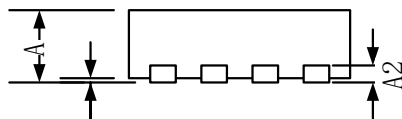
TDFN2x2-8



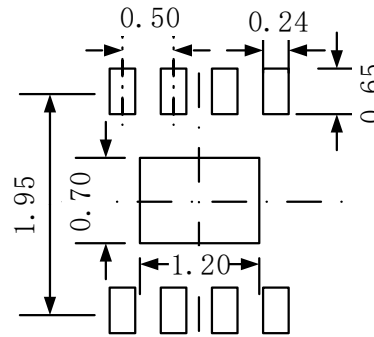
TOP VIEW



BOTTOM VIEW



SIDE VIEW



RECOMMENDED LAND PATTERN (Unit: mm)

Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.700	0.800	0.028	0.031
A1	0.000	0.050	0.000	0.002
A2	0.203(TYP)		0.008(TYP)	
b	0.180	0.300	0.007	0.012
D	1.900	2.100	0.075	0.083
D1	1.100	1.300	0.043	0.051
E	1.900	2.100	0.075	0.083
E1	0.600	0.800	0.024	0.031
e	0.500(TYP)		0.020(TYP)	
L	0.250	0.450	0.010	0.018